

**DXTP03200BP5**

**200V PNP HIGH VOLTAGE TRANSISTOR**  
**PowerDI<sup>®</sup>5**


**Features**

- 43% smaller than SOT223; 60% smaller than TO252
- Maximum height just 1.1mm
- Rated up to 3.2W
- $V_{CEO} = -200V$
- $I_C = -2A$ ;  $I_{CM} = -5A$
- Low Saturation voltage
- **Lead, Halogen, and Antimony Free/RoHS Compliant (Note 1)**
- **“Green” Device (Note 2)**

**Application**

- DC – DC conversion

**Mechanical Data**

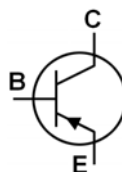
- Case: PowerDI<sup>®</sup>5
- Case Material: Molded Plastic, “Green” Molding Compound.  
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin annealed over Copper leadframe.  
Solderable per MIL-STD-202, Method 208 
- Weight: 0.093 grams (approximate)



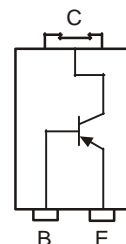
Top View



Bottom View



Device Schematic



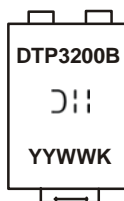
Pin-out diagram

**Ordering Information** (Note 3)

Part Number	Case	Packaging
DXTP03200BP5-13	PowerDI <sup>®</sup> 5	5000/Tape & Reel

- Notes:
1. No purposefully added lead. Halogen and Antimony Free.
  2. Diodes Inc's “Green” Policy can be found on our website at <http://www.diodes.com>
  3. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

**Marking Information**



DTP3200B = Product Type Marking Code  
011 = Manufacturers' Code Marking  
K = Factory Designator  
YYWW = Date Code Marking  
YY = Last Two Digits of Year (ex: 09 for 2009)  
WW = Week code (01 to 53)

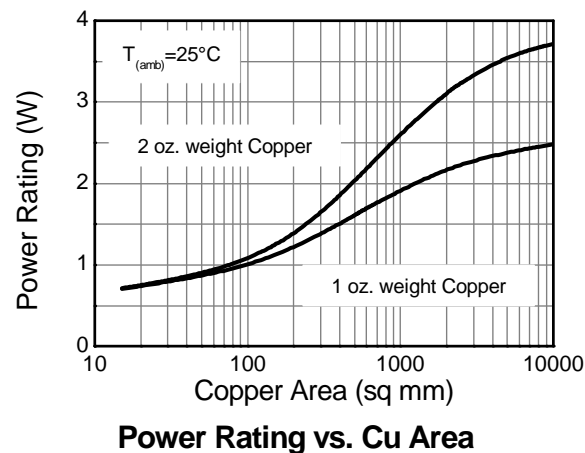
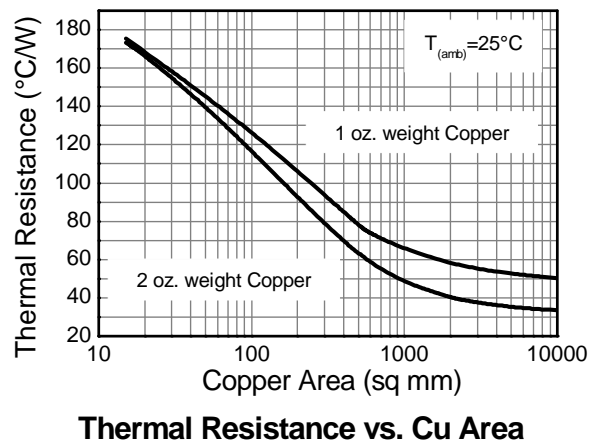
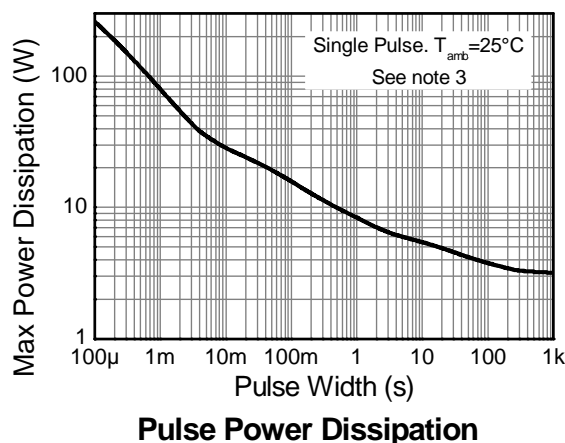
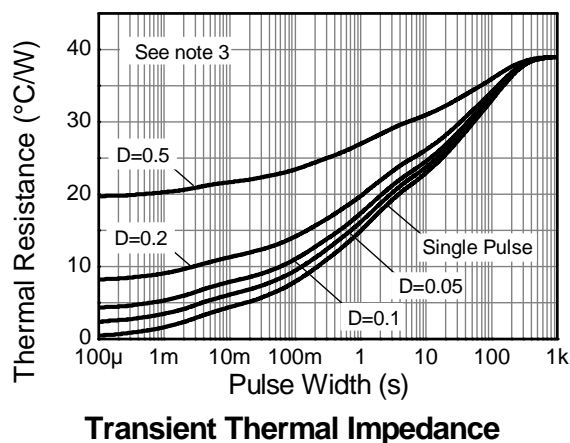
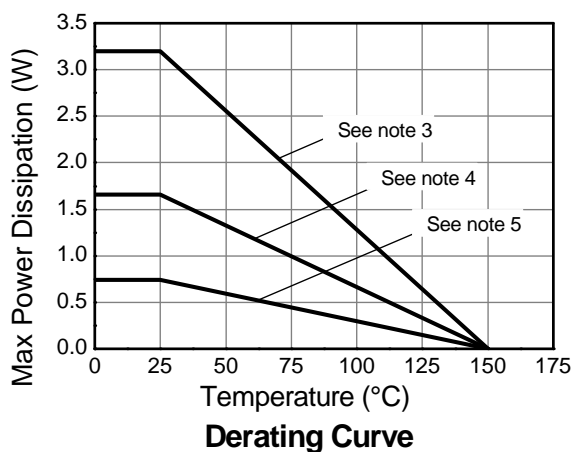
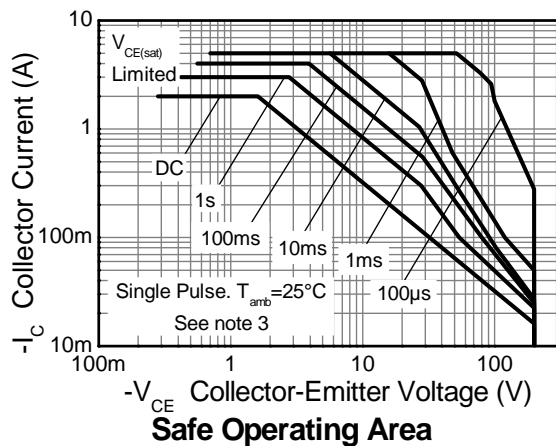
## Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-220	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-200	V
Emitter-Base Voltage	V <sub>EBO</sub>	-7	V
Continuous Collector Current	I <sub>C</sub>	-2	A
Base Current	I <sub>B</sub>	-1	A
Peak Pulse Current	I <sub>CM</sub>	-5	A

## Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation @ T <sub>A</sub> = 25°C (Note 4)	P <sub>D</sub>	3.2	W
Thermal Resistance, Junction to Ambient Air (Note 4) @T <sub>A</sub> = 25°C	R <sub>θJA</sub>	39	°C/W
Power Dissipation @ T <sub>A</sub> = 25°C (Note 5)	P <sub>D</sub>	1.7	W
Thermal Resistance, Junction to Ambient Air (Note 5) @T <sub>A</sub> = 25°C	R <sub>θJA</sub>	75	°C/W
Power Dissipation @ T <sub>A</sub> = 25°C (Note 6)	P <sub>D</sub>	0.74	W
Thermal Resistance, Junction to Ambient Air (Note 6) @T <sub>A</sub> = 25°C	R <sub>θJA</sub>	169	°C/W
Thermal Resistance, Junction to Collector Terminal	R <sub>θJT</sub>	5.6	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

- Notes:
4. Device mounted on FR-4 PCB, single sided 2 oz. copper, collector pad dimensions 25mm x 25mm.
  5. Device mounted on FR-4 PCB, single sided 1 oz. copper, collector pad dimensions 25mm x 25mm.
  6. Device mounted on FR-4 PCB, single sided 1 oz. copper, minimum recommended pad layout.

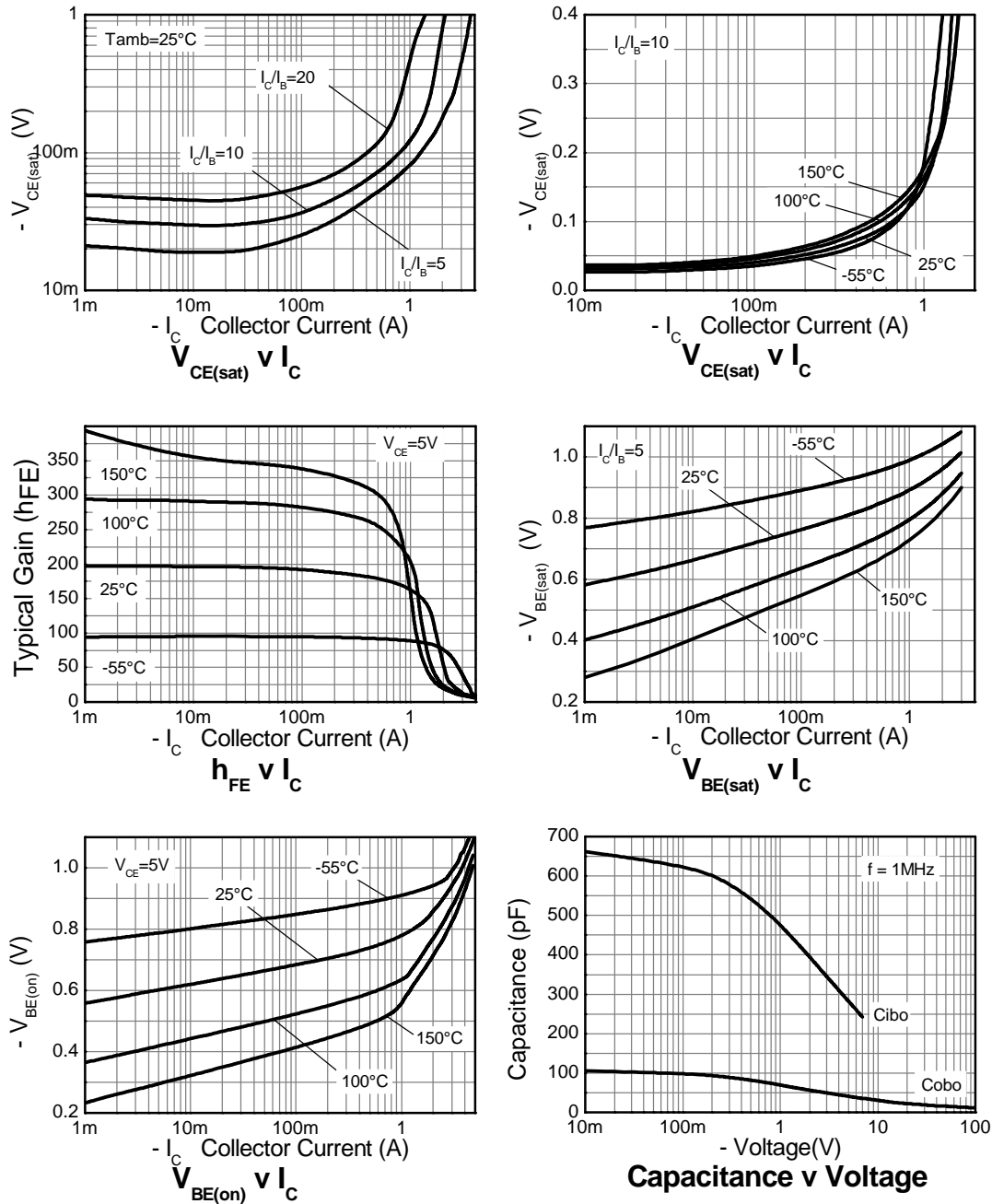


## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

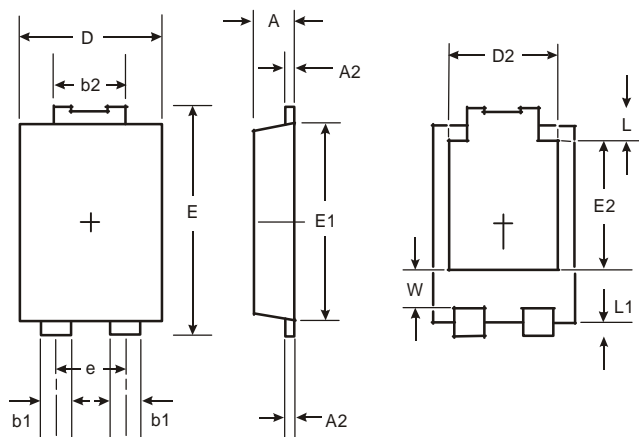
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-220	-245	–	V	I <sub>C</sub> = -100μA
Collector-Emitter Breakdown Voltage (Note 7)	V <sub>(BR)CEO</sub>	-200	-225	–	V	I <sub>C</sub> = -10mA
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-7	-8.4	–	V	I <sub>E</sub> = -100μA
Collector Cutoff Current	I <sub>CBO</sub>	–	<1	-50	nA	V <sub>CB</sub> = -200V
Emitter Cutoff Current	I <sub>EBO</sub>	–	<1	-10	nA	V <sub>CB</sub> = -200V, T <sub>A</sub> = 100 °C
Collector-Emitter Saturation Voltage (Note 7)	V <sub>CE(sat)</sub>	–	-37	-50	mV	I <sub>C</sub> = -0.1A, I <sub>B</sub> = -10mA
		–	-130	-155		I <sub>C</sub> = -0.5A, I <sub>B</sub> = -25mA
		–	-135	-160		I <sub>C</sub> = -1A, I <sub>B</sub> = -100mA
		–	-180	-275		I <sub>C</sub> = -2A, I <sub>B</sub> = -400mA
Base-Emitter Saturation Voltage (Note 7)	V <sub>BE(sat)</sub>	–	-955	-1100	mV	I <sub>C</sub> = -2A, I <sub>B</sub> = -400mA
Base-Emitter Turn-On Voltage (Note 7)	V <sub>BE(on)</sub>	–	-860	-1000	mV	V <sub>CE</sub> = -5V, I <sub>C</sub> = -2A
DC Current Gain (Note 7)	h <sub>FE</sub>	100	195	–	–	V <sub>CE</sub> = -5V, I <sub>C</sub> = -10mA
		100	170	300		V <sub>CE</sub> = -5V, I <sub>C</sub> = -1A
		20	50	–		V <sub>CE</sub> = -5V, I <sub>C</sub> = -2A
		–	5	–		V <sub>CE</sub> = -5V, I <sub>C</sub> = -5A
Transition Frequency	f <sub>T</sub>	–	105	–	MHz	V <sub>CE</sub> = -10V, I <sub>C</sub> = -100mA, f = 50MHz
Output Capacitance	C <sub>obo</sub>	–	31	–	pF	V <sub>CB</sub> = -10V, f = 1MHz
Delay Time	t <sub>d</sub>	–	21	–	ns	V <sub>CC</sub> = -50V, I <sub>C</sub> = -1A, I <sub>B1</sub> = -I <sub>B2</sub> = -100mA
Rise Time	t <sub>r</sub>	–	18	–	ns	
Storage Time	t <sub>s</sub>	–	680	–	ns	
Fall Time	t <sub>f</sub>	–	75	–	ns	

Notes: 7. Pulse Test: Pulse width ≤300μs. Duty cycle ≤2.0%.

## Typical Characteristic

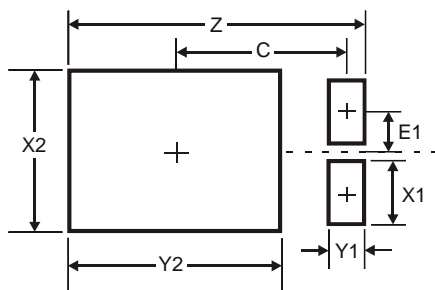


## Package Outline Dimensions



PowerDI <sup>®</sup> 5		
Dim	Min	Max
A	1.05	1.15
A2	0.33	0.43
b1	0.80	0.99
b2	1.70	1.88
D	3.90	4.05
D2	3.054 Typ	
E	6.40	6.60
e	1.84 Typ	
E1	5.30	5.45
E2	3.549 Typ	
L	0.75	0.95
L1	0.50	0.65
W	1.10	1.41
All Dimensions in mm		

## Suggested Pad Layout



Dimensions	Value (in mm)
Z	6.6
X1	1.4
X2	3.6
Y1	0.8
Y2	4.7
C	3.87
E1	0.9

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